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Serial Number: 10/698,503

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Inventor Information for 10/698503

Inventor Name	City	State/Country
GIESKES, KOENRAAD	DEPOSIT	NEW YORK

Appln Info	Contents	Petition Info	Atty/Agent Info	Continuity Data	Foreign Data	Inventors
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US 20050091845 A1	20050505	Method of component rejection from a placement head	29/833	29/739; 29/832	Gieskes, Koenraad
US 20050062302 A1	20050324	Low maintenance vacuum generation	294/64.2	294/64.1	Gieskes, Koen A. et al.
US 20040074085 A1	20040422	Integrated air flow control for a pick and place spindle assembly	29/743	29/739; 414/752.1	Gieskes, Koenraad Alexander et al.
US 20040060170 A1	20040401	Redundant system for assembly of electronic components to substrates	29/740	198/345.3; 29/760; 29/832	Gieskes, Koenraad A.
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US 20020092886 A1	20020718	Method and apparatus for balling and assembling ball grid array and chip scale array packages	228/41	228/180.22; 228/248.1	Adriance, James H. et al.
US 20020079751 A1	20020627	Variable reluctance motor with reduced	310/51	310/68R	Janisiewicz, Stanislaw Wladyslaw et al.

		noise and vibration			
US 20020079192 A1	20020627	Dual lane conveying apparatus	198/445		Dionne, Peter J. et al.
US 20020047437 A1	20020425	Variable reluctance motor with reduced noise and vibration	310/168	310/12; 310/216	Janisiewicz, Stanislaw Wladyslaw et al.
US 20010045788 A1	20011129	Variable reluctance motor with improved tooth geometry	310/216	310/12; 310/254	Janisiewicz, Stanislaw Wladyslaw et al.
US 20010026101 A1	20011004	Variable reluctance motor	310/12		Janisiewicz, Stanislaw Wladyslaw et al.
US 6848338 B1	20050201	High acceleration spindle drive and method of using same	74/821	414/752.1; 74/816	Gieskes; Koenraad Alexander et al.
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US 6460692 B2	20021008	Dual lane conveying apparatus	198/836.3	198/890	Dionne; Peter J. et al.
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US 5739846 A	19980414	Method of inspecting component placement accuracy for each first selected circuit board to be assembled of a batch	348/87	348/125; 348/86; 348/94; 348/95	Gieskes; Koen A.
US 5699934 A	19971223	Dispenser and method for dispensing viscous fluids	222/1	222/386.5; 222/61	Kolcun; Joseph F. et al.

US 5649356 A	19970722	Method and apparatus for supplying and placing components	29/833	29/710; 29/740; 29/743; 29/834; 294/64.1	Gieskes; Koen A.
US 5031818 A	19910716	Soldering machine operating with a protective gas and provided with automatically operating lock doors	228/42	228/221; 228/43	Gieskes; Koen A.
US 4848640 A	19890718	Apparatus for the application of a conductive adhesive medium to a printed circuit board	228/37	228/180.1	Gieskes; Koenraad A.

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